

RELIABILITY REPORT FOR MAX8934EETI+ PLASTIC ENCAPSULATED DEVICES

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# MAXIM INTEGRATED PRODUCTS

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#### Conclusion

The MAX8934EETI+ successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

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#### I. Device Description

A. General

The MAX8934\_ dual-input Li+/Li-Poly linear battery chargers with Smart Power Selector(tm) safely charge a single Li+/Li-Poly cell in accordance with JEITA recommendations. The MAX8934\_ monitors the battery temperature (TBATT) while charging, and automatically adjusts the fast-charge current and charge termination voltage as the battery temperature varies. The MAX8934\_ also monitors the battery temperature while the battery is discharging, and provides a warning flag (active-low OT) to the system in the event that the battery is over temperature. Two safety profiles are supported (see Figure 6 in the full data sheet for details). An ultra-low IQ, always-on LDO provides an additional 3.3V supply for system power. The MAX8934\_ operates with either separate inputs for USB\* and AC adapter power, or from a single input that accepts both. All power switches for charging and switching the load between battery and external power are included on-chip. No external MOSFETs are required. The MAX8934\_ features a Smart Power Selector to make the best use of limited USB or adapter power. Input current limit and battery charge current limit are independently set. Input power not used by the system charges the battery. Charge current limit and DC current limit can be set up to 1.5A and 2A, respectively, while USB input current can be set to 100mA or 500mA for the MAX8934A/MAX8934B/MAX8934C/MAX8934E and up to 1.5A (max) for the MAX8934D. Automatic input selection switches the system load from battery to external power. The MAX8934A provides a SYS output voltage of 5.3V, while the MAX8934B-MAX8934E provide a SYS output voltage of 4.35V. Other features include overvoltage protection (OVP), open-drain charge status and fault outputs, power-OK monitors, charge timers, and a battery thermistor monitor. Additionally, on-chip thermal limiting reduces the battery charge-rate to prevent charger overheating. The MAX8934\_ is available in a 28-pin, 4mm x 4mm, TQFN package.



# II. Manufacturing Information

A. Description/Function:Dual-Input Linear Chargers, Smart Power Selector with Advanced Battery<br/>Temperature MonitoringB. Process:S45C. Number of Device Transistors:12940D. Fabrication Location:California, Texas or JapanE. Assembly Location:Thailand

January 18, 2010

III. Packaging Information

F. Date of Initial Production:

A. Package Type:	28-pin TQFN 4x4
B. Lead Frame:	Copper
C. Lead Finish:	100% matte Tin
D. Die Attach:	Conductive
E. Bondwire:	Au (1.3 mil dia.)
F. Mold Material:	Epoxy with silica filler
G. Assembly Diagram:	#
H. Flammability Rating:	Class UL94-V0
I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C	Level 1
J. Single Layer Theta Ja:	48°C/W
K. Single Layer Theta Jc:	2.7°C/W
L. Multi Layer Theta Ja:	35°C/W
M. Multi Layer Theta Jc:	2.7°C/W

# IV. Die Information

Dimensions:	104 X 101 mils
Passivation:	Si <sub>3</sub> N <sub>4</sub> /SiO <sub>2</sub> (Silicon nitride/ Silicon dioxide)
Interconnect:	Al/0.5%Cu with Ti/TiN Barrier
Backside Metallization:	None
Minimum Metal Width:	Metal1 = 0.5 / Metal2 = 0.6 / Metal3 = 0.6 microns (as drawn)
Minimum Metal Spacing:	Metal1 = 0.45 / Metal2 = 0.5 / Metal3 = 0.6 microns (as drawn)
Bondpad Dimensions:	5 mil. Sq.
Isolation Dielectric:	SiO <sub>2</sub>
Die Separation Method:	Wafer Saw
	Dimensions: Passivation: Interconnect: Backside Metallization: Minimum Metal Width: Minimum Metal Spacing: Bondpad Dimensions: Isolation Dielectric: Die Separation Method:



#### V. Quality Assurance Information

Α.	Quality Assurance Contacts:	Don Lipps (Manager, Reliability Engineering) Bryan Preeshl (Managing Director of QA)
В.	Outgoing Inspection Level:	<ul><li>0.1% for all electrical parameters guaranteed by the Datasheet.</li><li>0.1% For all Visual Defects.</li></ul>
	Observed Outgoing Defect Rate:	< 50 ppm
D.	Sampling Plan:	Mil-Std-105D

## VI. Reliability Evaluation

#### A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (  $\lambda$ ) is calculated as follows:

 $\lambda = \underbrace{1}_{\text{MTTF}} = \underbrace{\frac{1.83}{192 \times 4340 \times 96 \times 2}}_{\text{(where 4340 = Temperature Acceleration factor assuming an activation energy of 0.8eV)}$  $\lambda = 11.5 \times 10^{-9}$  $\lambda = 11.5 \text{ F.I.T. (60\% confidence level @ 25°C)}$ 

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at http://www.maxim-ic.com/qa/reliability/monitor. Cumulative monitor data for the S45 Process results in a FIT Rate of 0.49 @ 25C and 8.49 @ 55C (0.8 eV, 60% UCL)

#### B. Moisture Resistance Tests

The industry standard 85°C/85%RH or HAST testing is monitored per device process once a quarter.

#### C. E.S.D. and Latch-Up Testing

The PQ56 die type has been found to have all pins able to withstand a HBM transient pulse of +/-2500V per JEDEC JESD22-A114. Latch-Up testing has shown that this device withstands a current of +/-250mA.



# Table 1 Reliability Evaluation Test Results

### MAX8934EETI+

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	
Static Life Test	(Note 1)				
	Ta = 135°C	DC Parameters	96	0	
	Biased	& functionality			
	Time = 192 hrs.				
Moisture Testing	g (Note 2)				
HAST	Ta = 130°C	DC Parameters	77	0	
	RH = 85%	& functionality			
	Biased				
	Time = 96hrs.				
Mechanical Stre	ss (Note 2)				
Temperature	-65°C/150°C	DC Parameters	77	0	
Cycle	1000 Cycles	& functionality			
	Method 1010				

Note 1: Life Test Data may represent plastic DIP qualification lots.

Note 2: Generic Package/Process data